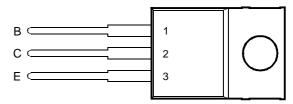
- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability
- 75 W at 25°C Case Temperature

TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT		
Collector-base voltage (I _E = 0)	TIPL760	V _{CBO}	850	٧	
Contactor base voltage (ig = 0)	TIPL760A	∨ СВО	1000		
Collector-emitter voltage (V _{RF} = 0)	TIPL760	V _{CES}	850	\/	
Concetor entitles voltage (VBE = 0)	TIPL760A	*CES	1000	v	
Collector-emitter voltage (I _R = 0)	TIPL760	V _{CEO}	400	V	
Collector-entitler voltage (IB = 0)	TIPL760A	VCEO	450		
Emitter-base voltage	V _{EBO}	10	V		
Continuous collector current	I _C	4	Α		
Peak collector current (see Note 1)	I _{CM}	8	Α		
Continuous device dissipation at (or below) 25°C case temperature	P _{tot}	75	W		
Operating junction temperature range	T _j	-65 to +150	°C		
Storage temperature range	T_{stg}	-65 to +150	°C		

NOTE 1: This value applies for $t_p \le 10$ ms, duty cycle $\le 2\%$.



TIPL760, TIPL760A NPN SILICON POWER TRANSISTORS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

	TEST CONDITIONS				MIN	TYP	MAX	UNIT		
V _{CEO(sus)}	Collector-emitter sustaining voltage	I _C =	10 mA	L = 25 mH	(see Note 2)	TIPL760 TIPL760A	400 450			٧
I _{CES}	Collector-emitter cut-off current	$V_{CE} = 0$ $V_{CE} = 0$	1000 V 850 V 1000 V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	T _C = 100°C T _C = 100°C	TIPL760 TIPL760A TIPL760 TIPL760A			50 50 200 200	μА
I _{CEO}	Collector cut-off current	V _{CE} = V _{CE} =	400 V 450 V	$I_{B} = 0$ $I_{B} = 0$		TIPL760 TIPL760A			50 50	μΑ
I _{EBO}	Emitter cut-off current	V _{EB} =	10 V	I _C = 0					1	mA
h _{FE}	Forward current transfer ratio	V _{CE} =	5 V	$I_{\rm C} = 0.5 {\rm A}$	(see Notes 3 ar	nd 4)	20		60	
V _{CE(sat)}	Collector-emitter saturation voltage	I _B = I _B = I _B =	0.5 A 0.8 A 0.8 A	$I_{C} = 2.5 \text{ A}$ $I_{C} = 4 \text{ A}$ $I_{C} = 4 \text{ A}$	(see Notes 3 ar	nd 4)			1.0 2.5 5.0	V
V _{BE(sat)}	Base-emitter saturation voltage	I _B = I _B = I _B =	0.5 A 0.8 A 0.8 A	$I_{C} = 2.5 \text{ A}$ $I_{C} = 4 \text{ A}$ $I_{C} = 4 \text{ A}$	(see Notes 3 ar	nd 4)			1.2 1.4 1.3	V
f _t	Current gain bandwidth product	V _{CE} =	10 V	I _C = 0.5 A	f = 1 MHz			12		MHz
C _{ob}	Output capacitance	V _{CB} =	20 V	$I_E = 0$	f = 0.1 MHz			110		рF

NOTES: 2. Inductive loop switching measurement.

- 3. These parameters must be measured using pulse techniques, t_p = 300 μs , duty cycle \leq 2%.
- 4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

	PARAMETER			MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t _{sv}	Voltage storage time	I _C = 4 A V _{BE(off)} = -5 V		(see Figures 1 and 2)			2.5	μs
t _{rv}	Voltage rise time						300	ns
t _{fi}	Current fall time		$I_{B(on)} = 0.8 A$				250	ns
t _{ti}	Current tail time						150	ns
t _{xo}	Cross over time						400	ns
t _{sv}	Voltage storage time	I _C = 4 A V _{BE(off)} = -5 V	$I_{B(on)} = 0.8 \text{ A}$ $T_C = 100^{\circ}\text{C}$	(see Figures 1 and 2)			3	μs
t _{rv}	Voltage rise time						500	ns
t _{fi}	Current fall time						250	ns
t _{ti}	Current tail time						150	ns
t _{xo}	Cross over time						750	ns

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PRODUCT INFORMATION

PARAMETER MEASUREMENT INFORMATION

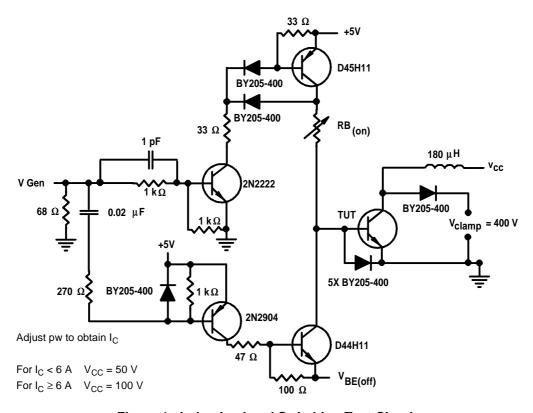
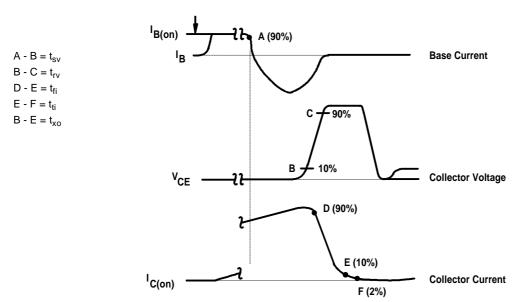


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15$ ns, $R_{in} > 10 \Omega$, $C_{in} < 11.5$ pF. B. Resistors must be noninductive types.

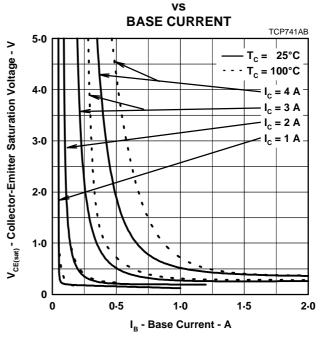
Figure 2. Inductive-Load Switching Waveforms

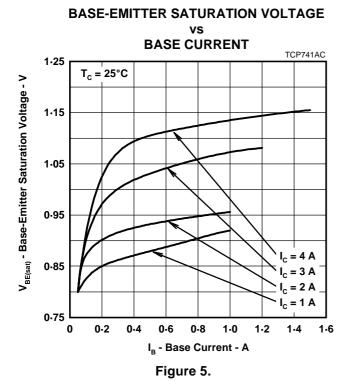


TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN VS COLLECTOR CURRENT TCP741AA Tc = 125°C Tc = -65°C V_{CE} = 5 V V_{CE} = 5 V I_C - Collector Current - A Figure 3.

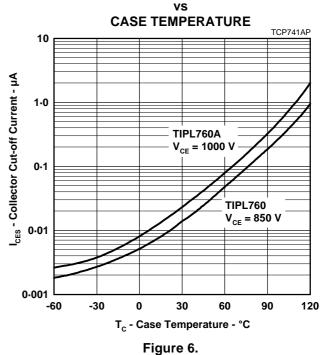
COLLECTOR-EMITTER SATURATION VOLTAGE





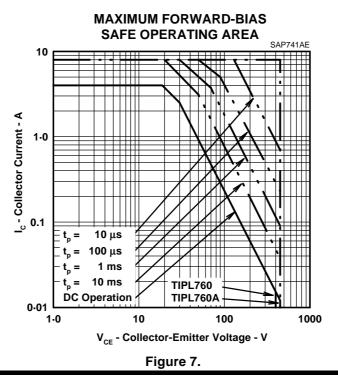
COLLECTOR CUT-OFF CURRENT

Figure 4.



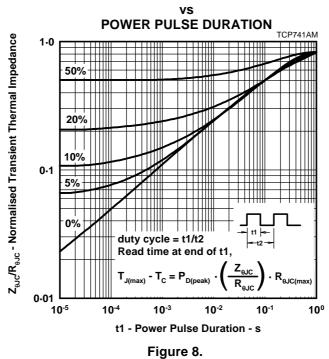
PRODUCT INFORMATION

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE

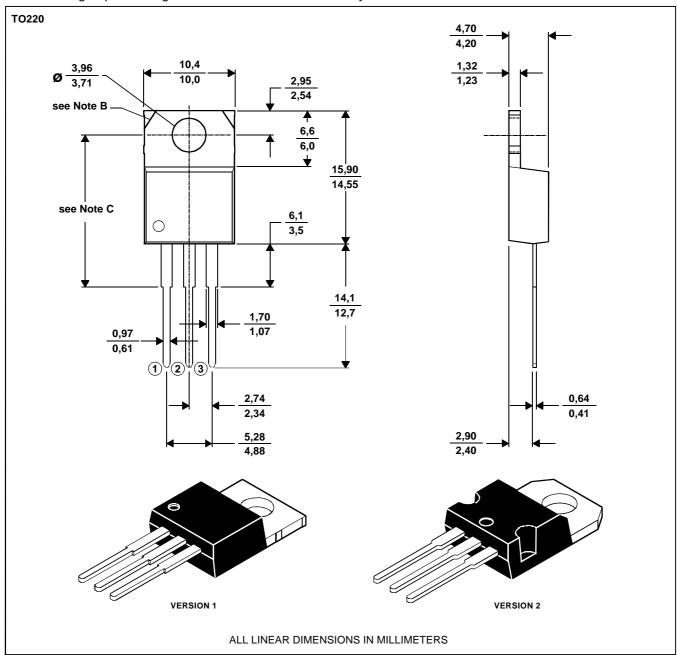


MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm. **MDXXBE**

PRODUCT INFORMATION

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